TOSHIBA PHOTOCOUPLER IRED & PHOTO-IC

TLP105

Isolated bus drivers
High-speed line receivers
Microprocessor system interfaces

The Toshiba TLP105 consists of an infrared emitting diode optically coupled to a high-gain, high-speed photodetector.

The TLP105 is housed in a 6-pin MFSOP.

With a totem-pole output, the TLP105 is capable of both sinking and sourcing current.

The TLP105 has an internal Faraday shield, which provides a guaranteed common-mode transient immunity of ± 10 kV/ μs .

The TLP105 has a noninverting output. An inverting output version, the TLP108, is also available.

- Buffer logic type (totem-pole output)
- Guaranteed Performance Over Temperature: -40 to 100°C
- Power Supply Voltage: 4.5 to 20 V
- Input Threshold Current: IFLH =1.6 mA (max)
- Switching Time (t_{pLH}/t_{pHL}): 250 ns (max)
- Common mode transient immunity: ±10 kV/μs
- Isolation Voltage: 3750 Vrms
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A

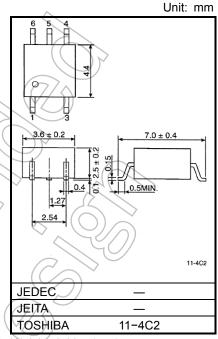
File No.E67349

VDE-approved: EN 60747-5-5 (Note 1)

Note 1: When a VDE approved type is needed, please designate the **Option(V4)**.

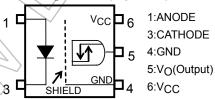
Truth Table

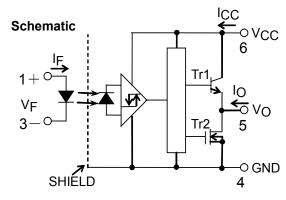
Input	> LED	Tr1	Tr2	Output
Н	ON	ON	OFF	Н
L	OFF	OFF	ON	L



Weight: 0.09 g (typ.)

Pin Configuration (top View)





0.1 μF bypass capacitor must be connected between pin 6 and 4.

Start of commercial production 2008-05

Recommended Operating Conditions

CHARACTERISTIC	SYMBOL	MIN	TYP.	MAX	UNIT
Input Current, ON	I _{F(ON)}	2		10	mA
Input Voltage, OFF	V _F (OFF)	0		0.8	V
Supply Voltage*	V _{CC}	4.5	_	20	V
Operating Temperature	T _{opr}	-40	_	100	°C ⟨
Fan-out (TTL Load)	N			4	

^{*} This item denotes operating range, not meaning of recommended operating conditions.

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Absolute Maximum Ratings (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT
	Forward Current		20 🔷	mA
	Forward Current Derating (Ta ≥ 83°C)	ΔF/°C	-0.48	mA/°C
	Peak Transient Forward Current (Note1)	IFPT	1 ((A
=	Reverse Voltage	\vee_{V_R}	5	<i></i>)y
	Input Power Dissipation	P _D	(40)	mW
	Input Power Dissipation derating (Ta ≥ 83°C)	ΔPD/°C	-0.95	mW/°C
	Output Current 1 (Ta ≤ 25°C)	/01	25/-15	mA
	Output Current 2 (Ta ≤ 100°C)	102	5/-5	mA
ᄶ	Output Current Derating (Ta ≥ 25°C)	∆01/°C	-0.26/-0.13	mA/°C
CTOR	Peak Output Current (Note2)	_ lop	50/-50	mA
DETE(Output Voltage	Vo	-0.5 to 20	V
	Output Power Dissipation	Po	75	mW
	Output Power Dissipation Derating (Ta ≥ 25°C)	ΔP ₀ /°C	-0.75	mW/°C
	Supply Voltage	V _{CC}	-0.5 to 20	V
Oper	ating Temperature Range	T _{opr}	-40 to 100	°C
Stora	ge Temperature Range	T _{stq}	-55 to 125	°C
Lead	Solder Temperature (10 s)	T _{sol}	260	°C
Isolat	tion Voltage (AC, 60 s, R.H. \leq 60 %) (Note3)	BVs	3750	V _{rms}

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Pulse width \leq 1 μ s, 300 pps.

Note 2: Pulse width $\leq 5~\mu s,$ duty cycle ≤ 0.025

Note 3: Device considered a two terminal device: pins 1 and 3 shorted together and pins 4, 5 and 6 shorted together.

Electrical Characteristics (Unless otherwise specified, Ta = -40 to 100°C, V_{CC} = 4.5 to 20 V)

CHARACTERISTIC	SYMBOL	TEST CIRCUIT	CONI	DITION	MIN	TYP.	MAX	UNIT
Input Forward Voltage	VF	_	I _F = 10 mA, Ta = 25 °C		1.45	1.57	1.75	٧
Temperature Coefficient of Forward Voltage	ΔV _F /ΔΤα		I _F =10 mA			-2.0		mV/°C
Input Reverse Current	IR	-	V _R = 5 V, Ta = 25	5° C	+	4	10	μА
Input Capacitance	СТ	_	V = 0 V, f = 1 MH	Iz, Ta = 25 °C		100	-	pF
Logic Low Output Voltage	V _{OL}	1	I _{OL} = 3.5 mA, V _F	= 0.8 V	//-5)	0.2	0.6	V
	.,		I _{OH} = −2.6 mA,	VCC = 4.5 V	2.7	4.0		.,
Logic High Output Voltage	Vон	2	I _F = 5 mA	V _{CC} = 20 V	17.4	19.0	_	V
Logic Low Supply Current	ICCL	3	V _F = 0 V	Vcc = 20 V Vcc = 5.5 V			3.0	mA
Logic High Supply Current	Іссн	4	I _F = 5 mA	V _{CC} = 20 V V _{CC} = 5.5 V	\		3.0	mA
Logic Low Short Circuit Output Current (Note 1)	I _{OSL}	5	V _F = 0 V	$V_{CC} = V_{O} = 5.5 \text{ V}$ $V_{CC} = V_{O} = 20 \text{ V}$	15	80 90	_ _	mA
Logic High Short Circuit Output Current (Note 1)	losh	6	IF = 5 mA Vo = GND	V _{CC} = 5.5 V V _{CC} = 20 V	-5 -10	-15 -20	_ _	mA
Input Current Logic High Output	I _{FLH}		I _O = -2.6 mA, V _O	> 2.4 V	_	0.4	1.6	mA
Input Voltage Logic Low Output	VFHL		1 _O = 3.5 mA, V _O < 0.4 V		0.8	_	_	V
Input Current Hysteresis	IHYS		Vcc = 5 V	7/		0.05		mA

^{*}All typical values are at Ta = 25 °C/

Note 1: Duration of output short circuit time should not exceed 10 ms.

Note: A ceramic capacitor $(0.1 \, \mu A)$ should be connected from pin 6 to pin 4 to stabilize the operation of the high gain linear amplifier. Failure to provide the bypassing may impair the switching property. The total lead length between capacitor and coupler should not exceed 1 cm.

Isolation Characteristics (Ta = 25°C)

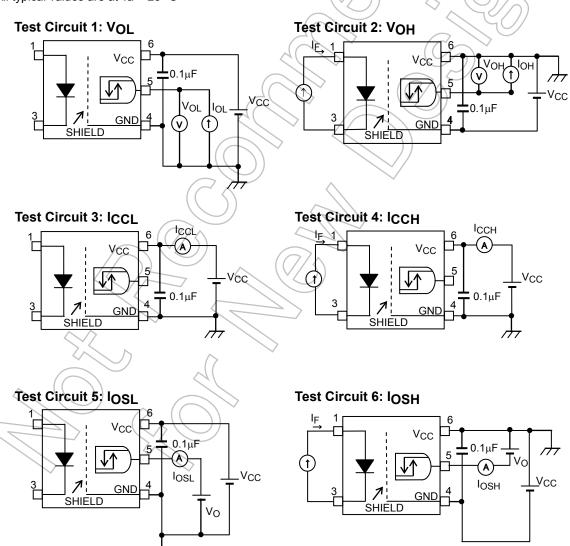
Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	$\langle \rangle$	Cs	V _S = 0 V, f = 1 MHz	-	8.0	_	pF
Isolation resistance		Rs	R.H. \leq 60 %, V _S = 500 V	1×10 ¹²	10 ¹⁴	_	Ω
Isolation voltage		BVS	AC,60 s	3750	_	1	V _{rms}

Switching Characteristics

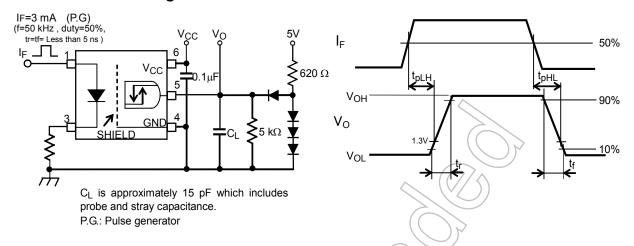
(Unless otherwise specified, Ta = -40 to 100°C, VCC = 4.5 to 20 V)

CHARACTERISTIC	SYMBOL	TEST CIRCUIT	CONDITION	MIN	TYP.	MAX	UNIT
Propagation Delay Time to Logic High output	t _{pLH}		I _F = 0→3 mA	30	150	250	ns
Propagation Delay Time to Logic Low output	t _P HL		I _F = 3→0 mA	30	150	250	ns
Switching Time Dispersion between ON and OFF	t _{pHL} -t _{pLH}	7, 8	_) ((220	ns
Rise Time (10 – 90 %)	tr		I _F = 0→3 mA , V _{CC} = 5 V	$\langle \nabla \rangle$))30	75	ns
Fall Time (90 – 10 %)	t _f		I _F = 3→0 mA , V _{CC} =5 V))	30	75	ns
Common Mode transient Immunity at High Level Output	CM _H		V _{CM} = 1000 V _{p-p} , I _F = 5 mA, V _{CC} =20 V, Ta = 25 °C	-10000			V/μs
Common Mode transient Immunity at Low Level Output	CML	9	$V_{CM} = 1000 V_{p-p}, I_F = 0 \text{ mA},$ $V_{CC} = 20 \text{ V}, T_a = 25^{\circ} \text{ C}$	10000	3		V/μs

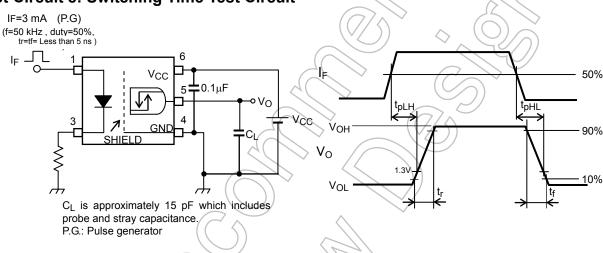
^{*}All typical values are at Ta = 25 $^{\circ}$ C



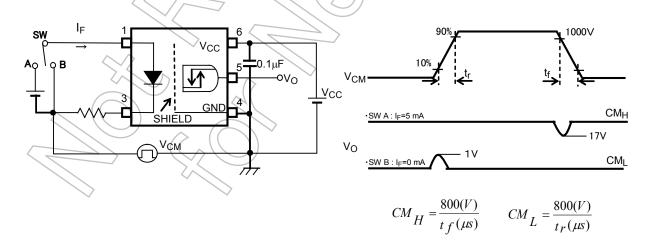
Test Circuit 7: Switching Time Test Circuit



Test Circuit 8: Switching Time Test Circuit



Test Circuit 9: Common Mode Transient Immunity Test Circuit



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